

Service Repair Documentation Level 3 (Basic) – ME75



Release	Date	Department	Notes to change
R 1.0	13.10.2005	BenQ Mobile CC S CES	New document

Table of Content

1	Introduction	3
1.1	PURPOSE	3
1.2	SCOPE	3
1.3	TERMS AND ABBREVIATIONS	3
2	List of available level 2.5light parts	4
3	Hardware requirements	4
4	ME75 Board layout	5
5	SIM Card Problems	6
6	IO Connector Problems	7
7	B to B connector Problems	8
8	Battery connector Problems	9
9	Camera Connector Problems	10
10	Main keypad illumination Problems	13

1 Introduction

1.1 Purpose

This Service Repair Documentation is intended to support Service partners to carry out repairs on BenQ repair level 3. The described failures shall only be repaired in BenQ authorized local workshops.

The level 3 (former Level 2.5light) partners are obliged to repair level 3 classified boards, up to their repair level, under consideration of this repair instruction.

All repairs have to be carried out in an ESD protected environment and with ESD protected equipment/tools. For all activities the international ESD regulations have to be considered.

Assembling/disassembling has to be done according to the latest ME75 Level 1-2 repair documentation. It has to be ensured that every repaired mobile Phone is checked according to the latest released General Test Instruction document (both documents are available in the Technical Support section of the C-market).

Check at least weekly C-market for updates and consider all ME75 related Customer Care Information

ME75 Partnumber on IMEI label: S30880-S6980-#xxx

, while # may be any letter (A-Z) and xxx may be any number from 100, 101, 102....

Scrap Handling: All Scrap information given in this manual are related to the SCRAP-Rules and instructions.

Attention: Consider the new "LEAD-FREE" soldering rules (available in the communication market), avoid excessive heat.

1.2 Scope

This document is the reference document for all BenQ mobile authorised Service Partners which are released to repair BenQ mobile phones up to level 2.5 light.

1.3 Terms and Abbreviations

2 List of available level 2.5light parts

(according to Component Matrix V1.09 - check C-market for updates)

Product	ID	Order Number	Description CM
ME75	S2931	L36315-Z77-C218	JOYSTICK
ME75	V2650	L36197-F5008-F492	IRDA 115.2 KBIT
ME75	X1400	L36334-Z97-C336	CONNECTOR BATTERY 3-POL R65
ME75	X1504	L36334-Z93-C303	IO-JACK SLIM 12-POL
ME75	X1604	L50634-Z97-C406	CONNECTOR SIM CARD READER R65 (B)
ME75	X2202	L36334-Z97-C205	CONNECTOR DISPLAY 10POL
ME75	X2705	L50634-Z97-C383	CONNECTOR BOARD TO BOARD 12-POL. X75
ME75	X3651	L50634-Z97-C379	CONNECTOR CAMERA-SOCKET
ME75	X3800	L36334-Z93-C297	CONNECTOR ANTENNA 6mm

3 Hardware requirements

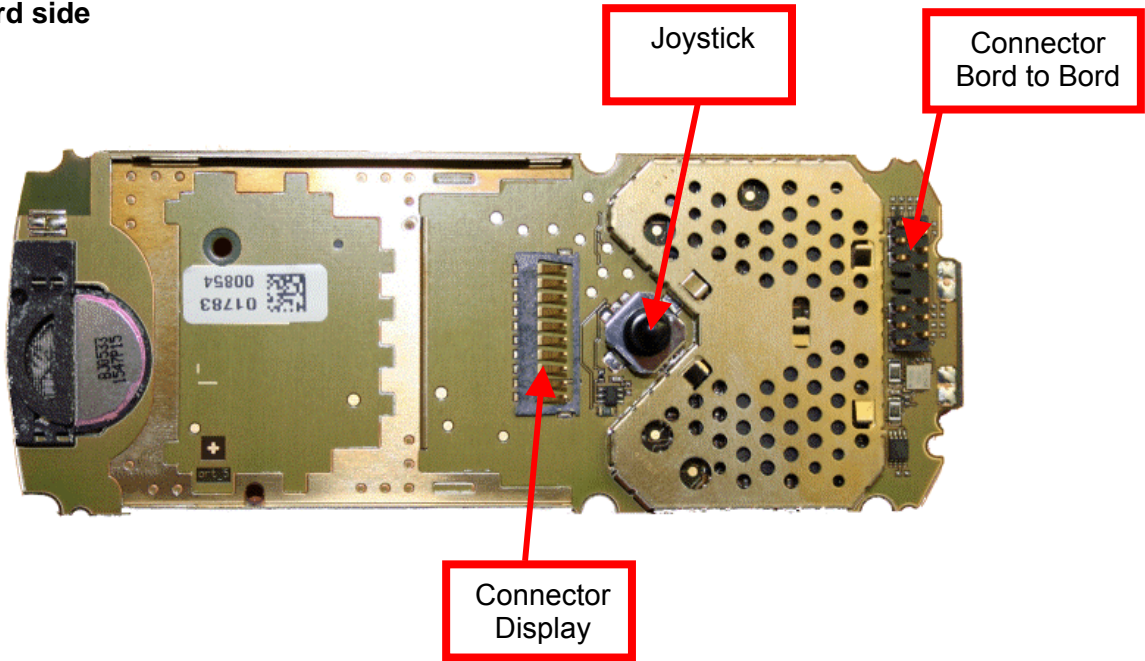
(according to L2.5L-L2.5 General soldering information V1.3 - check C-market for updates)

Jigs, Tools and working materials for all described repairs:

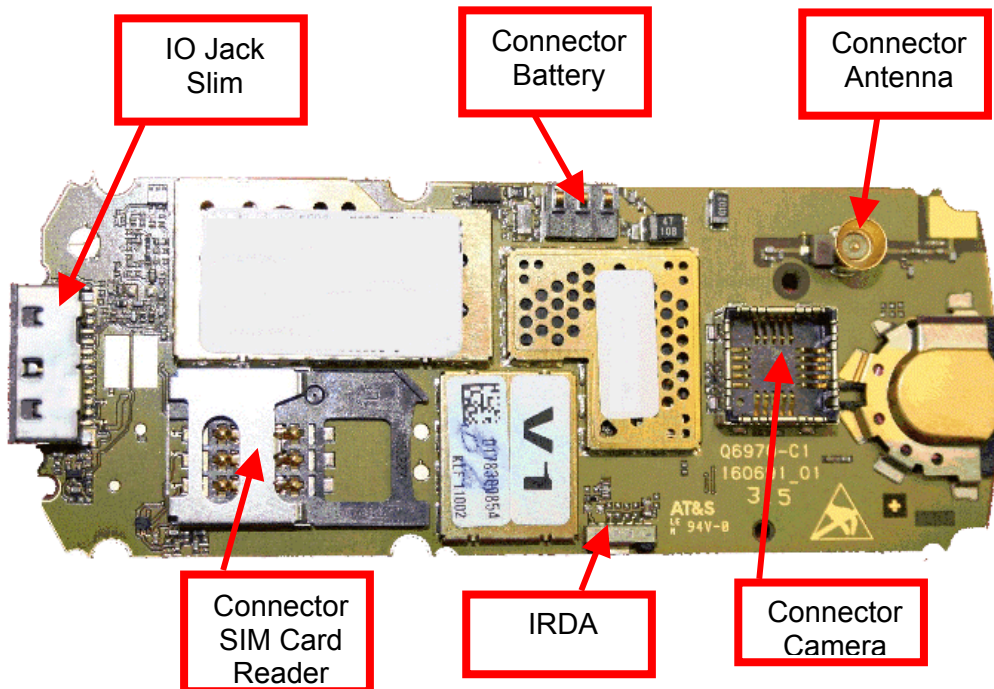
- hot air blower
- soldering gun
- tweezers
- flux
- solder
- ME75 dome sheet jig

4 ME75 Board layout

Upper board side

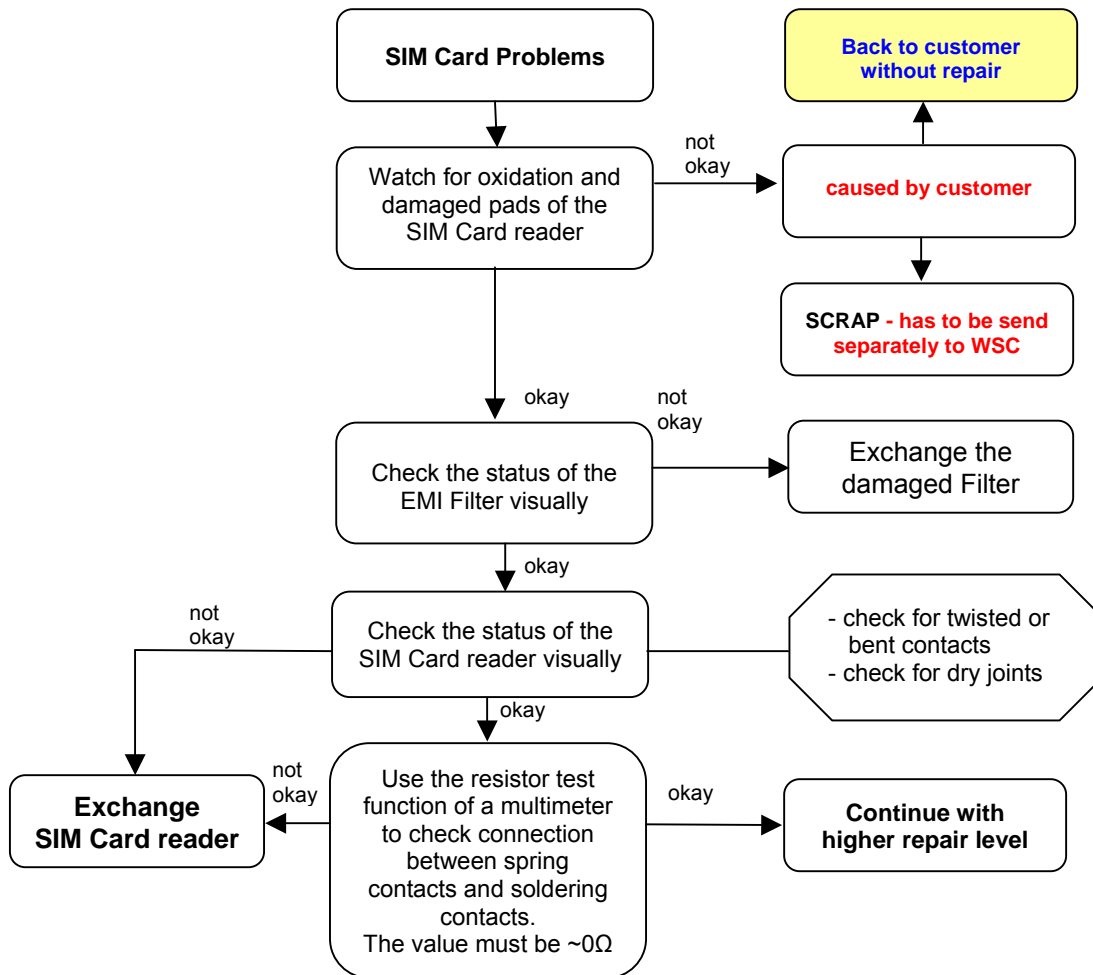


Lower board side



5 SIM Card Problems

Fault Symptoms	
Customer: Handset does not accept SIM card	GRT: SIM Card Problems



Connector SIM Card Reader

Use soldering iron to remove defective component. Avoid excessive heat! Watch surrounding components! Resolder new component afterwards.

E-commerce order number: L50634-Z97-C406

E-commerce order name: CONNECTOR SIM CARD READER R65 (B)

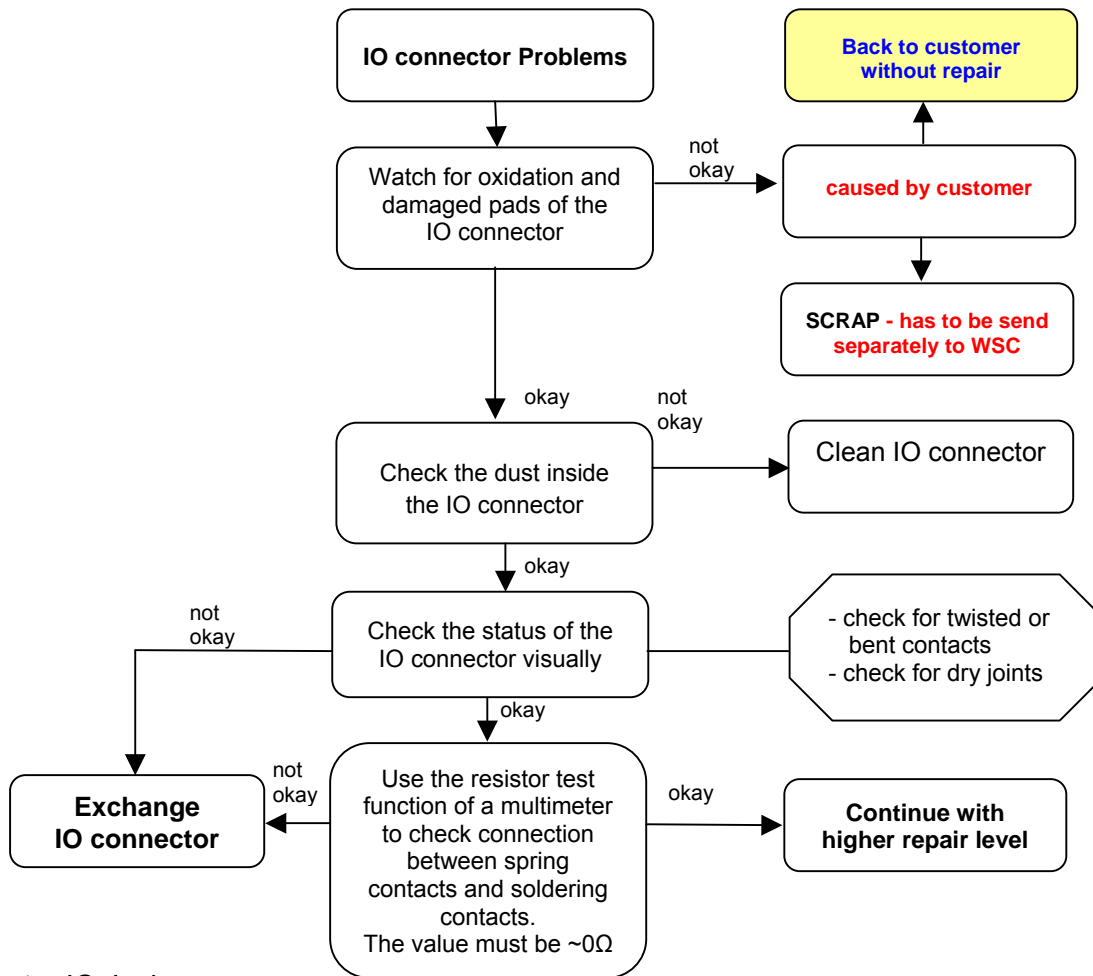
Soldering temperature: ~ 360°C TIP Temp.

IRIS Diagnose Code: 43300 Interface/SIM Card reader/Mechanical Damage

Technical Documentation	10/2005
TD_Repair_L2.5L_ME75_R1.0.pdf	Page 6 of 13

6 IO Connector Problems

Fault Symptoms	
Customer: Charging Problems Problems with external loudspeaker or microphone when using a car kit Problems with accessories connected at the IO connector	GRT: No connection to GRT



Connector IO Jack

Use soldering iron to remove defective component. Avoid excessive heat! Watch surrounding components! Resolder new component afterwards.

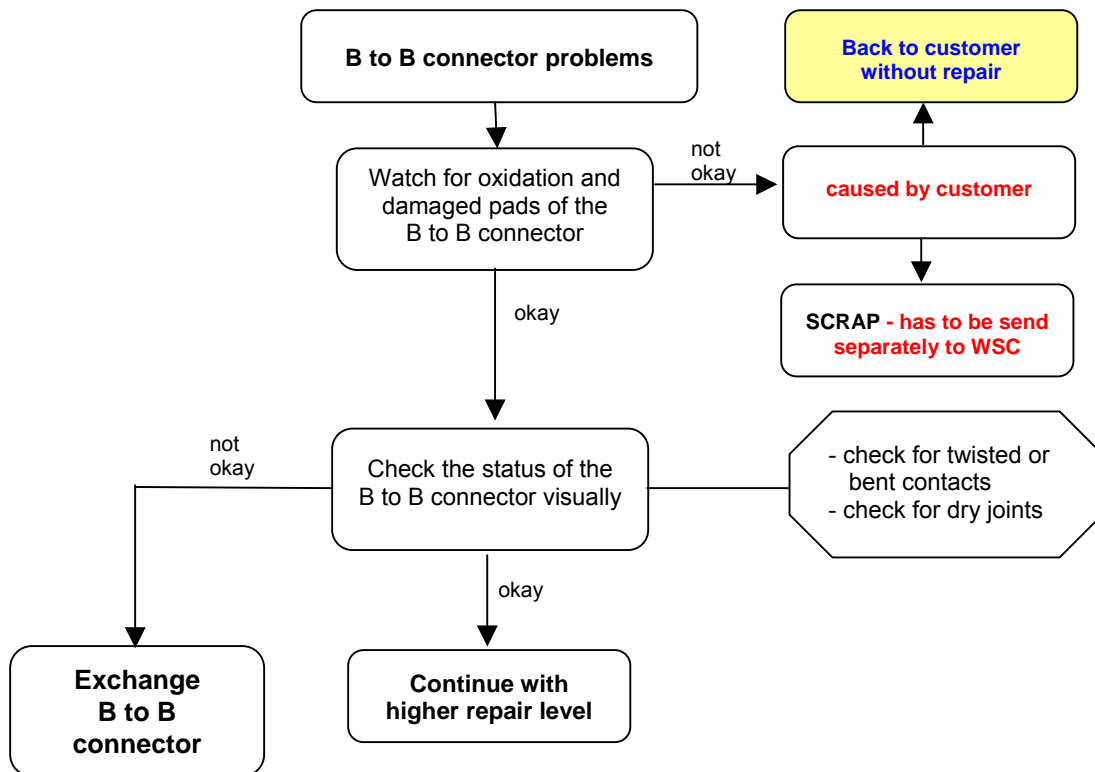
E-commerce order number: L36334-Z93-C303
 E-commerce order name: IO-JACK SLIM 12-POL
 Soldering temperature: ~ 360°C TIP Temp.

IRIS Diagnose Code: 46100 Interface/Charging Connector/Mechanical Damage
 47300 Interface/Data Interface/Mechanical Damage
 4B100 Interface/Headset Connector/Mechanical Damage

Technical Documentation	10/2005
TD_Repair_L2.5L_ME75_R1.0.pdf	Page 7 of 13

7 B to B connector Problems

Fault Symptoms	
Customer: Upper slider keyboard malfunction Upper slider keypad illumination does not work Display problems	GRT: Keyboard malfunction Current measured failed



Connector Board to Board

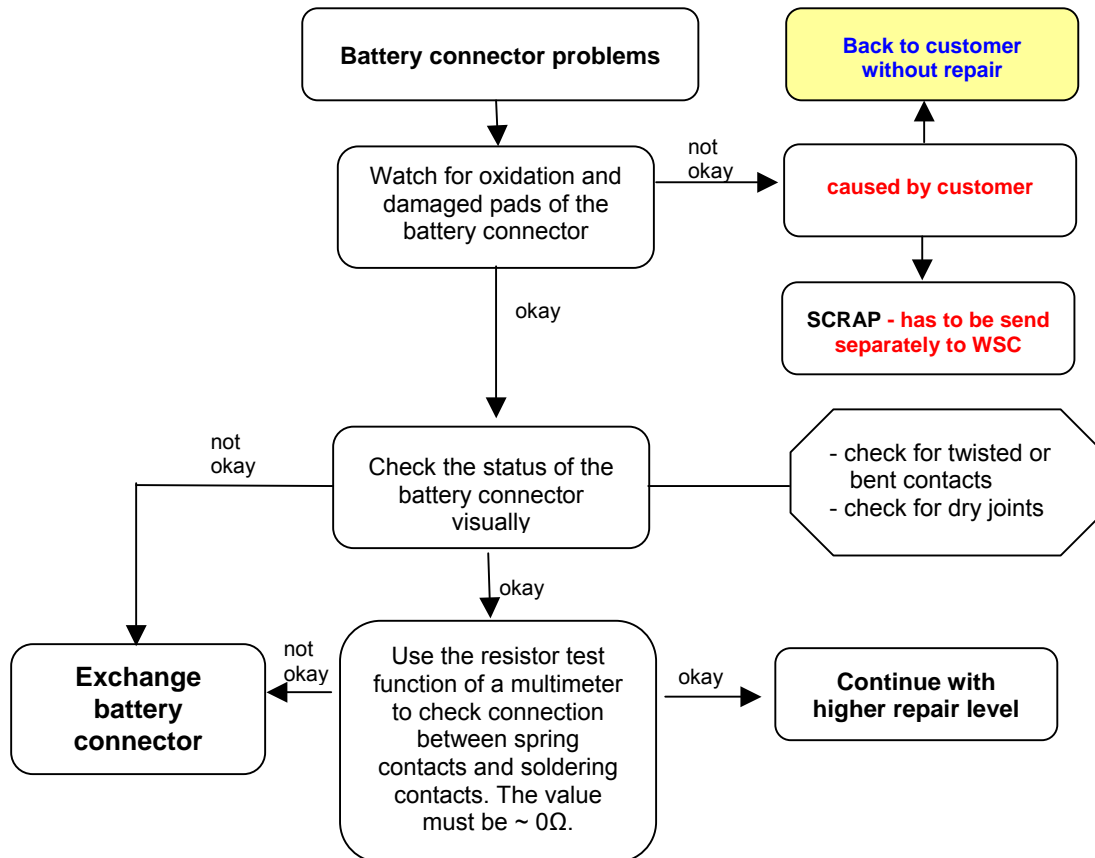
Use hot air blower to remove defective component. Avoid excessive heat! Watch surrounding components! Resolder new component afterwards.

E-commerce order number: L50634-Z97-C340
 E-commerce order name: BOARD TO BOARD 30-POL
 Soldering temperature: ~ 360°C TIP Temp.

IRIS Diagnose Code: 32100 Keys / Main / No Function
 32200 Keys / Main / Reduced Functionality
 36000 Keys / Illumination

8 Battery connector Problems

Fault Symptoms	
Customer: Mobile does not switch on	GRT: No connection to GRT



Connector BATTERY

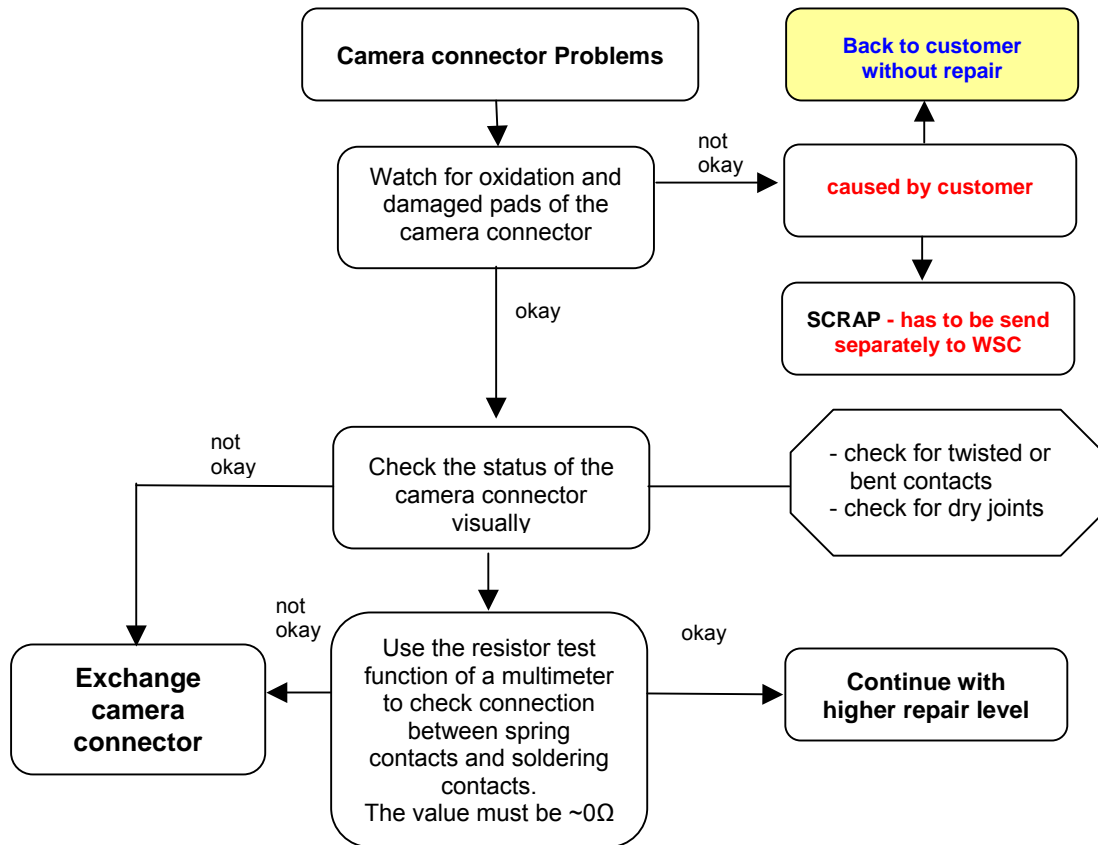
Use hot air blower to remove defective component. Avoid excessive heat! Watch surrounding components! Resolder new component afterwards.

E-commerce order number: L36334-Z97-C213
 E-commerce order name: CONNECTOR BATTERY 3-POL
 Soldering temperature: ~ 360°C TIP Temp.
 IRIS Diagnose Code: 13000 Battery/Mechanical Damage

Technical Documentation	10/2005
TD_Repair_L2.5L_ME75_R1.0.pdf	Page 9 of 13

9 Camera Connector Problems

Fault Symptoms	
Customer: Camera malfunction	GRT: Tbd.



Connector CAMERA

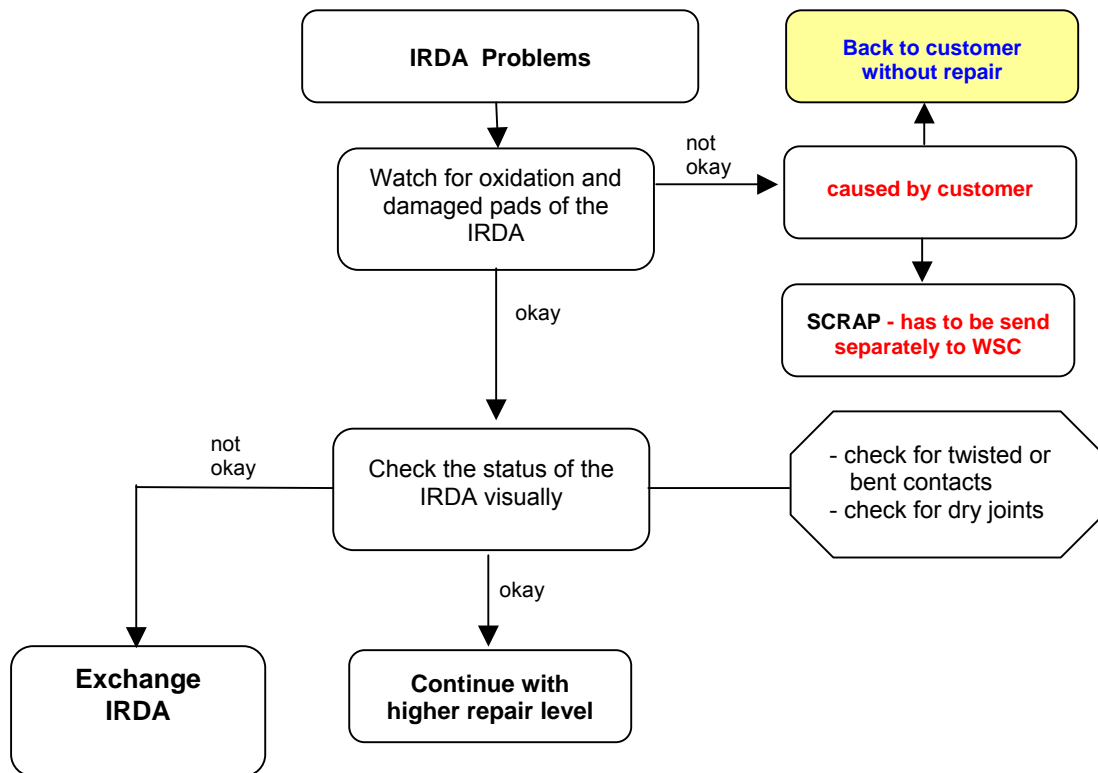
Use hot air blower to remove defective component. Avoid excessive heat! Watch surrounding components! Resolder new component afterwards.

E-commerce order number: L50634-Z97-C379
 E-commerce order name: CONNECTOR CAMERA-SOCKET
 Soldering temperature: ~ 360°C TIP Temp.
 IRIS Diagnose Code: BA000 Accessories / Camera

Technical Documentation	10/2005
TD_Repair_L2.5L_ME75_R1.0.pdf	Page 10 of 13

10 IRDA Problems

Fault Symptoms	
Customer: No infrared connection possible	GRT: Tbd.



IRDA

Use hot air blower to remove defective component. Avoid excessive heat! Watch surrounding components! Resolder new component afterwards.

E-commerce order number: L36197-F5008-F492

E-commerce order name: IRDA 115.2 KBIT

Soldering temperature: ~ 360°C TIP Temp.

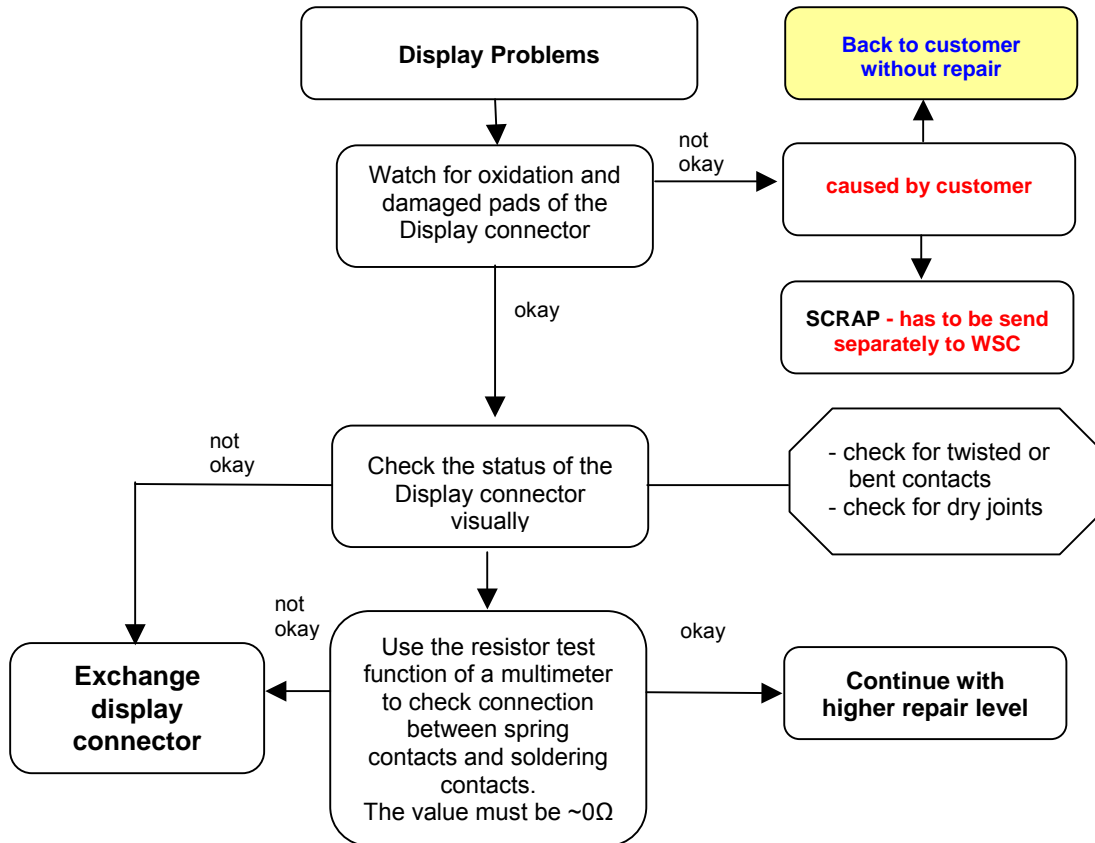
IRIS Diagnose Code: 41100 Interfaces / IRDA / No Function

41300 Interfaces / IRDA / Mechanical Damage

Technical Documentation	10/2005
TD_Repair_L2.5L_ME75_R1.0.pdf	Page 11 of 13

11 Display Problems

Fault Symptoms	
Customer: Display problems	GRT: Current measured failed



Connector DISPLAY

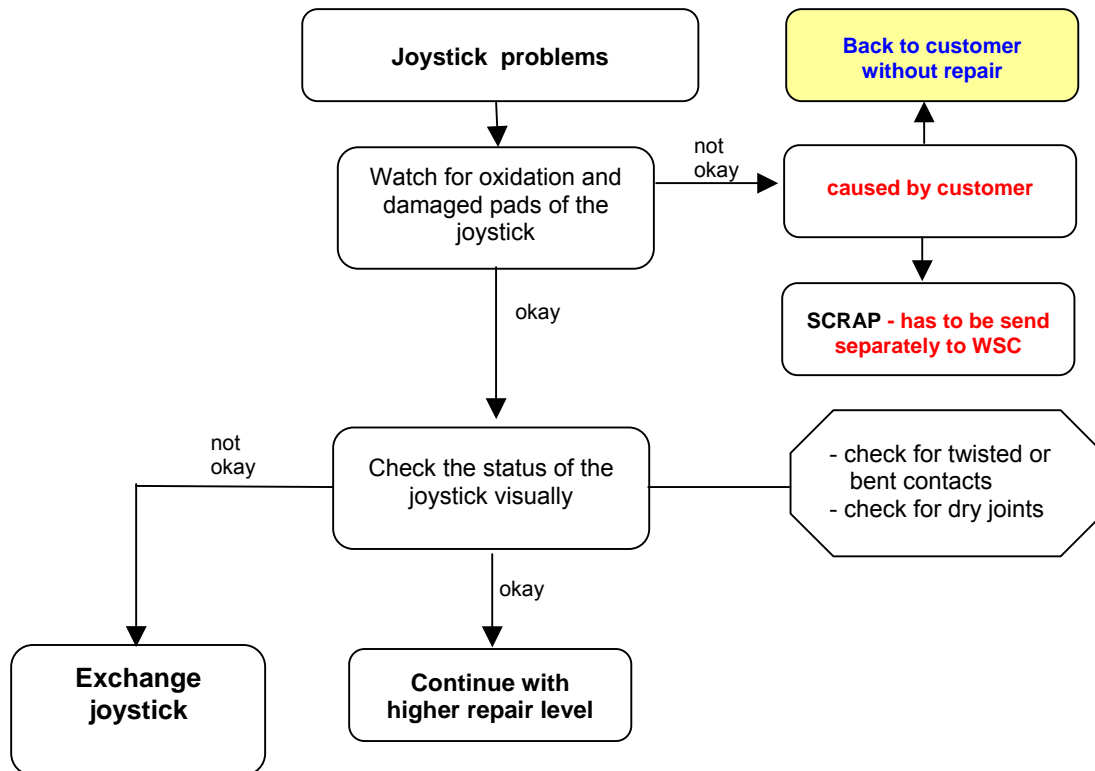
Use hot air blower to remove defective component. Avoid excessive heat! Watch surrounding components! Resolder new component afterwards.

E-commerce order number: L50634-Z97-C380
 E-commerce order name: CONNECTOR DISPLAY 20POL
 Soldering temperature: ~ 360°C TIP Temp.
 IRIS Diagnose Code: 21000 Display / Performance
 22000 Display / Background Illumination

Technical Documentation	10/2005
TD_Repair_L2.5L_ME75_R1.0.pdf	Page 12 of 13

12 Joystick Problems

Fault Symptoms	
Customer: Joystick malfunction	GRT: Tbd.



Joystick

Use hot air blower to remove defective component. Avoid excessive heat! Watch surrounding components! Resolder new component afterwards.

E-commerce order number: L36315-Z77-C218
 E-commerce order name: JOYSTICK
 Soldering temperature: ~ 360°C TIP Temp.
 IRIS Diagnose Code: 32100 Keys / Main / No Function
 32200 Keys / Main / Reduced Functionality

Technical Documentation	10/2005
TD_Repair_L2.5L_ME75_R1.0.pdf	Page 13 of 13